# TBF-2012-245-R1 THIN FILM BAND PASS FILTER

# 1. Feature:

- 1. 2.45GHz Thin Film Band Pass Filter
- 2. For ISM Band applications like Wireless LAN & Bluetooth.
- 3. Lead Free

# 2. Part Number

TBF 2012 - 245 - R1 \_ XX

(1) (2) (3) (4) (5)

Where

- (1) TBF : Thin Film Band Pass Filter
- (2) Size :

4 digits of number  $-2012 = 2.0 \times 1.25$  mm

- (3) Center Frequency : 245 = 2.45 GHz
- (4) Type

Refer to Table 3-1

(5) XX

Internal Code

#### 3. Ratings

3-1 Specifications

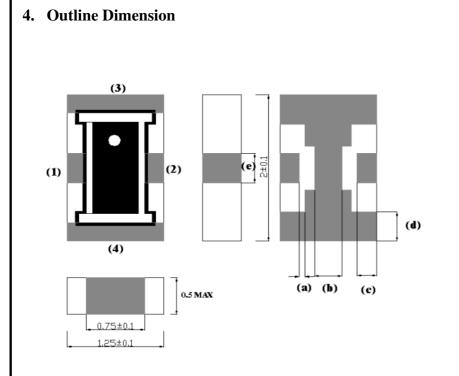
TBF-2012-245-R1
50 Ω
2450MHz
2400 ~ 2500MHz
1.5 dB Max. at +25 deg. C
1.8 dB max. at -40 ~ +85 deg. C
0.5dB max.
30.0dB min. at 880~960MHz
25.0dB min. at 1710~1910MHz
30.0dB min. at 4800 ~ 5000MHz
30.0dB min. at 7200 ~ 7500MHz (Option)
2.0 Max.
500mW Max.

3-2 Operation Temperature:  $-40^{\circ}$ C to  $+85^{\circ}$ C

3-3 Storage Temperature:  $+15^{\circ}$ C to  $+35^{\circ}$ C

			-		
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# Preliminary



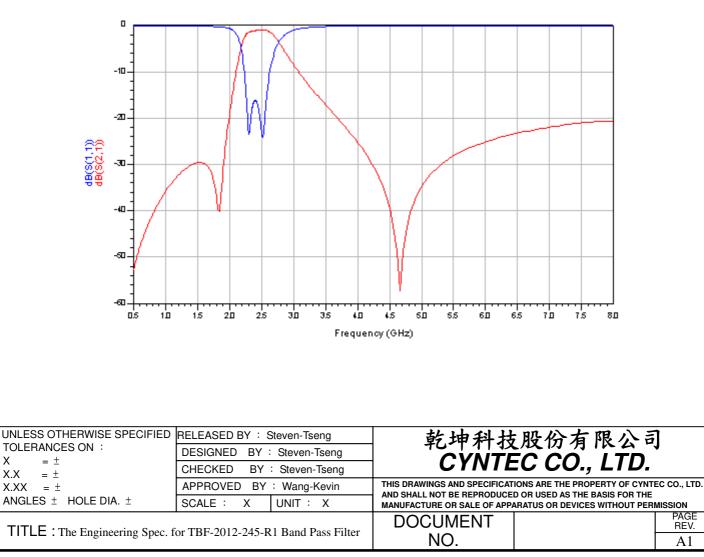
Code	Dimension
а	0.075 <u>+</u> 0.02
b	0.45 <u>+</u> 0.1
с	0.25 <u>+</u> 0.1
d	0.4 <u>+</u> 0.1
e	0.4 <u>+</u> 0.1

Unit : mm

**Terminal Configuration:** 

Terminal No.	Terminal Name
(1)	Input
(2)	Output
(3)	GND
(4)	GND

# **5.** Electrical Performance



# Preliminary

# 6. Recommended Land Pattern

GND			
	¬	— a	0.2 mm
		b	0.15 mm
50 ohm I/P	50 ohm	c	0.3 mm
50 ohm I/P e	• 0/P <sup>50</sup> ohm		
		d	0.35 mm
		e	0.3 mm
GND			
a b c	d		
	-		
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#### 7. Reliability Test

#### 7.1 Electrical

/.1 Electrical		
ITEM	Specification and Requirement	Test Method
Temperature Characteristics	Satisfy electrical characteristics	Solder the sample on PCB. Exposure at each temperature, $-40^{\circ}$ C, $-20^{\circ}$ C, $0^{\circ}$ C, $+25^{\circ}$ C, $+50^{\circ}$ C,
		+85°C for 30minutes

# 7.2 Mechanical

ITEM	Specification and Requirement	Test Method
Solderability	The Surface of terminal immersed shall be minimum of 95% covered with a new	Solder bath :
	coating of solder	<u>+ 5 °C molten solder bath for 2 +</u>
		$1.5$ C monten solder but for $2 \pm 0.5$ seconds
Resistance to solder Hea	t Satisfy electrical characteristics without distinct deformation in appearance	
Vibration	Satisfy electrical characteristics without Mechanical damage such as break	Vibrate as apply 20 to 2,000Hz, 186m/s <sup>2</sup> (19G) acceleration 1.5mm amplitude for 2 hours in each of three (X, Y, Z) axis (total 6 hours).
Shock	Satisfy electrical characteristics withour mechanical damaged such as break	<ul> <li>t (1) Break value : 490 N</li> <li>(2) Duration of pulse : 11ms</li> <li>(3) 3 times in each positive and negative direction of 3 mutual perpendicular directions.</li> </ul>
Bending Test	Satisfy electrical characteristics without mechanical damage such as break	
Solvent Resistant	Marking should be legible withou mechanical and distinct damage ir appearance	t(1) Solvent : Trichloroethane or
Drop Test	Satisfy electrical characteristics without mechanical damage	
	mechanical damage	Im to concrete ground for 10 times
DLERANCES ON : = ±	ELEASED BY : Steven-Tseng DESIGNED BY : Steven-Tseng CHECKED BY : Steven-Tseng CHECKED BY : Steven-Tseng	科技股份有限公司 NTEC CO., LTD.

SCALE :

APPROVED

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X.XX

= ± ANGLES  $\pm\,$  HOLE DIA.  $\pm\,$  BY : Wang-Kevin

UNIT : X

DOCUMENT

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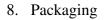
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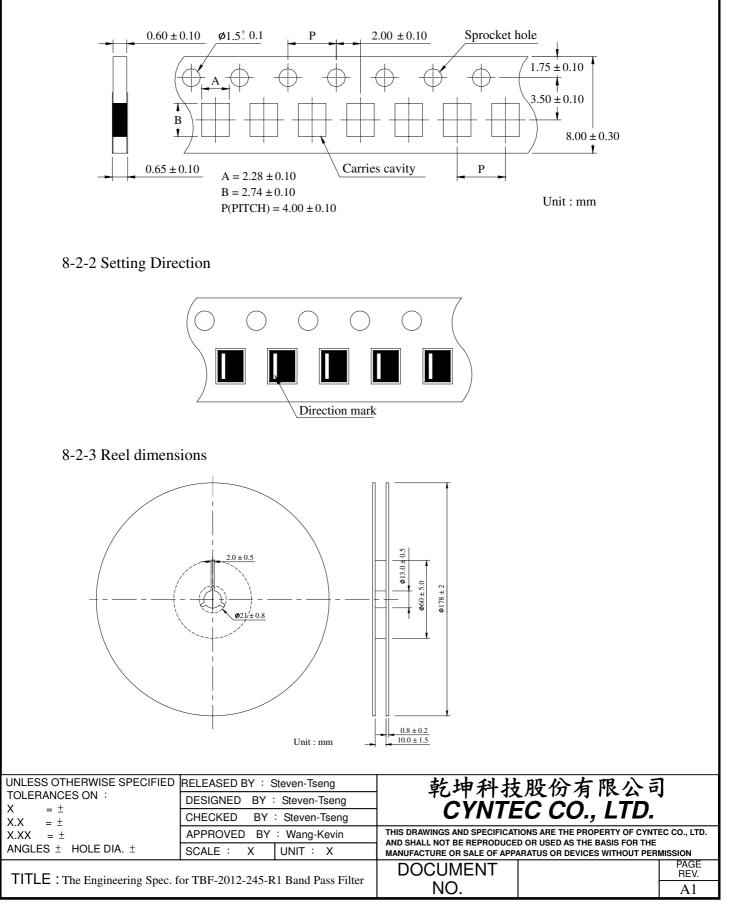
# 7.3 Load Life

ITEM	Specification and Requirement	Test Method
Rapid change of temperature	Satisfy Electrical Characteristics.	Perform 5 cycles as follows :
	Without distinct damage.	$-55^{\circ}$ C for 30minutes $\rightarrow$ room
		temperature for 3 minutes $\rightarrow$
		+125°C for 30minutes $\rightarrow$ room
		temperature for 3 minutes.
		(Dwell time : 5 to 8 minutes)
Humidity Resistance Test	Satisfy Electrical Characteristics.	Precondition at $+25^{\circ}$ C for 1hour.
	Without distinct damage.	Let stand at temperature $+40 \pm 3$
		$^{\circ}$ C, 90~95% relative humidity for
		1,000 hours before taking final
		measurements.
Low Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $-55 \pm 3^{\circ}$ C for 1,000
		hours.
		1~2 hours exposure at room
		temperature and humidity, prior to
		measurement.
High Temperature Store	Satisfy Electrical Characteristics.	Solder the sample on PCB.
	Without distinct damage.	Exposure at $+85 \pm 3^{\circ}$ C for 1,000
		hours.
		1~2 hours exposure at room
		temperature and humidity, prior to
		measurement.
Load Life	Satisfy Electrical Characteristics.	Apply 16 Volt voltage at 70±2°C
	Without distinct damage.	ambient

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- 8-1 Material : Paper Carrier Tape
- 8-2 Dimensions
  - 8-2-1 Tape packaging dimensions



# 8-3 Peel force of top cover tape The peel speed shall be about 300 mm/minute The peel force of top cover tape shall be between 10 to 70g Top Cover Tape 10-70g 8-4 Numbers of taping 4,000 pieces/reel 8-5 Label marking

The following items shall be marked on the production and shipping Label on the reel.

8-5-1 Production Label

- (1) Part No.
- (2) Description
- (3) Quantity
- (4) Taping No.

# 8-5-2 Shipping Label

- (1) \*Customer's name
- (2) \*Customer's part No.
- (3) Manufacturer's part No.
- (4) Manufacturer's name
- (5) Manufacturer's country
- \*Note : Item (1) and (2) are listed by request

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